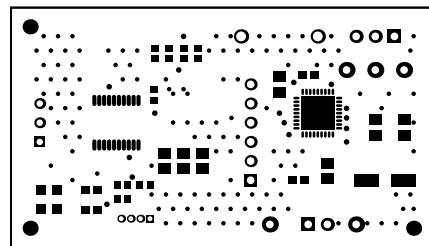
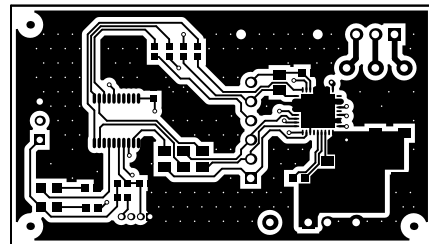


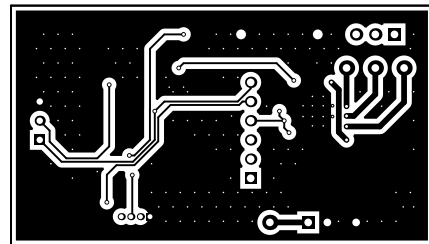
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01362	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: 01362		
PLOT NAME = Top Overlay	GENERATED : 2/14/2017 9:02:47 AM	TEXAS INSTRUMENTS	



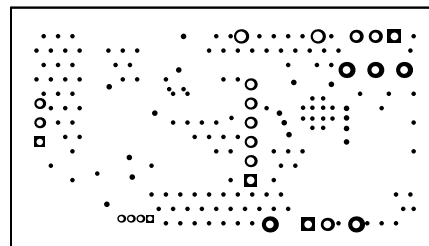
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01362	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: 01362		
PLOT NAME = Top Solder Mask	GENERATED : 2/14/2017 9:02:48 AM	TEXAS INSTRUMENTS	



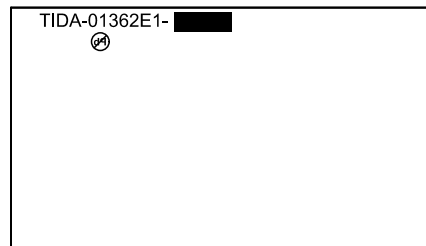
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01362	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: 01362		
PLOT NAME = Top Layer	GENERATED : 2/14/2017 9:02:50 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01362	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: 01362		
PLOT NAME = Bottom Layer	GENERATED : 2/14/2017 9:02:51 AM	TEXAS INSTRUMENTS	

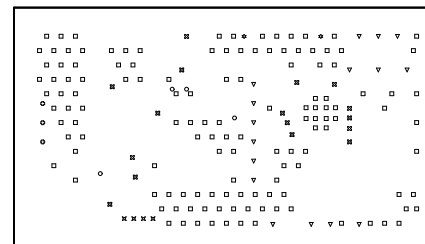


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01362	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: 01362		
PLOT NAME = Bottom Solder Mask	GENERATED : 2/14/2017 9:02:52 AM	TEXAS INSTRUMENTS	

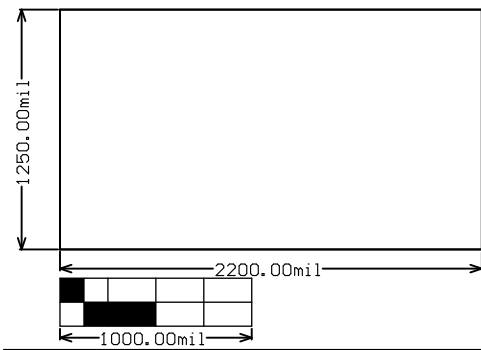


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01362	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: 01362		
PLOT NAME = Bottom Overlay	GENERATED : 2/14/2017 9:02:53 AM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
○	4	7.80mil (0.198mm)	PTH	Round	Top Layer - Bottom Layer	
□	133	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	16	15.00mil (0.381mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	4	25.59mil (0.650mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	3	33.46mil (0.850mm)	PTH	Round	Top Layer - Bottom Layer	
▽	16	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
☆	2	51.18mil (1.300mm)	PTH	Round	Top Layer - Bottom Layer	
	178 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01362	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: 01362		
PLOT NAME = Drill Drawing	GENERATED : 2/14/2017 9:02:55 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01362	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: 01362		
PLOT NAME = Board Dimensions	GENERATED : 2/14/2017 9:02:56 AM	TEXAS INSTRUMENTS	

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